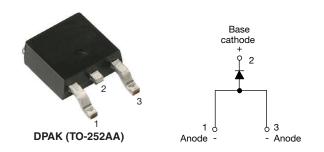


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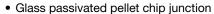
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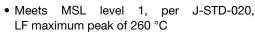
Surface Mount Fast Soft Recovery Rectifier Diode, 8 A



PRIMARY CHARACTERISTICS						
I _{F(AV)} 8 A						
V_{R}	1000 V, 1200 V					
V _F at I _F	1.3 V					
I _{FSM}	150 A					
t _{rr}	80 ns					
T _J max.	150 °C					
Snap factor	0.6					
Package	DPAK (TO-252AA)					
Circuit configuration	Single					

FEATURES











ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Output rectification and freewheeling diode in inverters, choppers and converters
- Input rectifications where severe restrictions on conducted EMI should be met

DESCRIPTION

The VS-8EWF..S-M3 fast soft recovery rectifier series has been optimized for combined short reverse recovery time, low forward voltage drop and low leakage current.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

MAJOR RATINGS AND CHARACTERISTICS							
SYMBOL	. CHARACTERISTICS VALUES U						
I _{F(AV)}	Sinusoidal waveform	8	A				
V _{RRM}		1000/1200	V				
I _{FSM}		150	A				
V _F	8 A, T _J = 25 °C	1.3	V				
t _{rr}	1 A, 100 A/µs	80	ns				
T _J	Range	-40 to +150	°C				

VOLTAGE RATINGS							
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} AT 150 °C mA				
VS-8EWF10S-M3	1000	1100	4				
VS-8EWF12S-M3	1200	1300	4				

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum average forward current	I _{F(AV)}	T _C = 96 °C, 180° conduction half sine wave	8				
Maximum peak one cycle		10 ms sine pulse, rated V _{RRM} applied	125	Α			
non-repetitive surge current	I _{FSM}	10 ms sine pulse, no voltage reapplied	150				
Maximum I2t for fusing	I ² t	10 ms sine pulse, rated V _{RRM} applied	78	A ² s			
waxiinum i-t ior iusing	ı-l	10 ms sine pulse, no voltage reapplied	110	A-S			
Maximum I ² √t for fusing	I ² √t	t = 0.1 ms to 10 ms, no voltage reapplied	1100	A ² √s			



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ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS VALUES UNIT				
Maximum forward voltage drop	V_{FM}	8 A, T _J = 25 °C		1.3	V	
Forward slope resistance	r _t	T _{.1} = 150 °C		25.6	mΩ	
Threshold voltage	V _{F(TO)}	1J = 150 C		0.93	V	
Maximum reverse leakage current		T _J = 25 °C	V - Poted V	0.1	mA	
Maximum reverse leakage current	I _{RM}	T _J = 150 °C	V _R = Rated V _{RRM}	4	IIIA	

RECOVERY CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	· •	
Reverse recovery time	t _{rr}	I _F at 8 A _{pk}	270	ns	I _{FM}	
Reverse recovery current	I _{rr}	25 A/μs	4.2	Α	$\left \begin{array}{c} \left \begin{array}{c} \overline{t_{rr}} \\ \overline{t_a} & \overline{t_h} \end{array}\right \right $	
Reverse recovery charge	Q _{rr}	T _J = 25 °C	1	μC	di/ dt/ Q	
Snap factor	S		0.6		l I I I I I I I I I I I I I I I I I I I	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction and storage temperature range	T _J , T _{Stg}		-40 to +150	°C		
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	2.5	°C/W		
Typical thermal resistance, junction to ambient (PCB mount)	R _{thJA} (1)		50	C/VV		
Approximate weight			1	g		
Approximate weight			0.03	oz.		
Marilian de la		Occupation DRAW (TO OFFICE)	8EWF	-10S		
Marking device		Case style DPAK (TO-252AA)	8EWF12S			

Note

⁽¹⁾ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 µm) copper 40 °C/W For recommended footprint and soldering techniques refer to application note #AN-994

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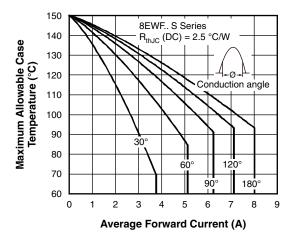


Fig. 1 - Current Rating Characteristics

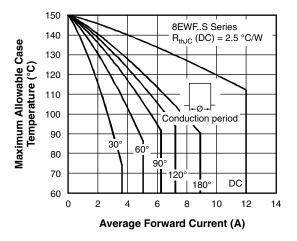


Fig. 2 - Current Rating Characteristics

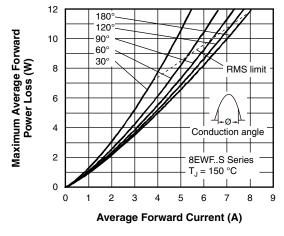


Fig. 3 - Forward Power Loss Characteristics

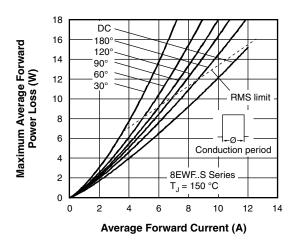


Fig. 4 - Forward Power Loss Characteristics

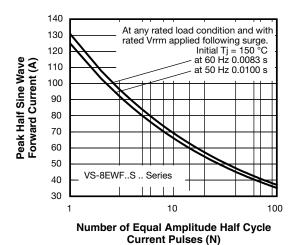


Fig. 5 - Maximum Non-Repetitive Surge Current

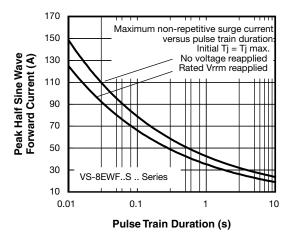


Fig. 6 - Maximum Non-Repetitive Surge Current



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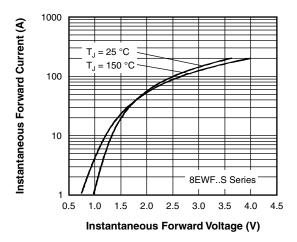


Fig. 7 - Forward Voltage Drop Characteristics

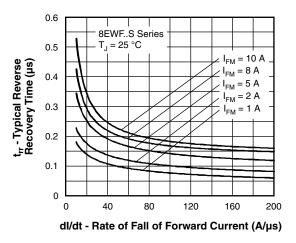


Fig. 8 - Recovery Time Characteristics, T_J = 25 °C

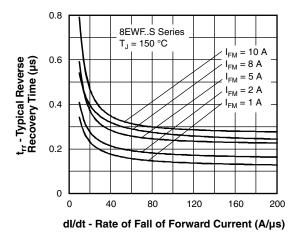


Fig. 9 - Recovery Time Characteristics, $T_J = 150 \, ^{\circ}\text{C}$

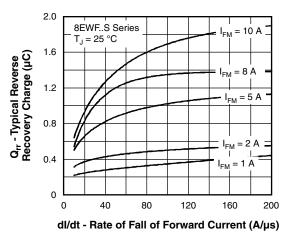


Fig. 10 - Recovery Charge Characteristics, T_{.I} = 25 °C

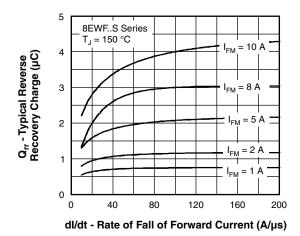


Fig. 11 - Recovery Charge Characteristics, T_J = 150 °C

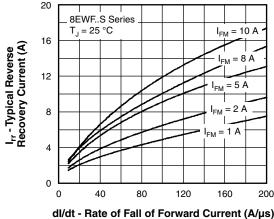


Fig. 12 - Recovery Current Characteristics, $T_J = 25$ °C

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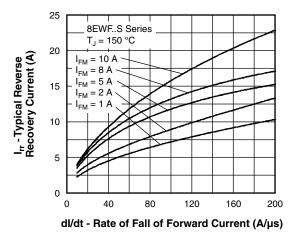


Fig. 13 - Recovery Current Characteristics, T_J = 150 °C

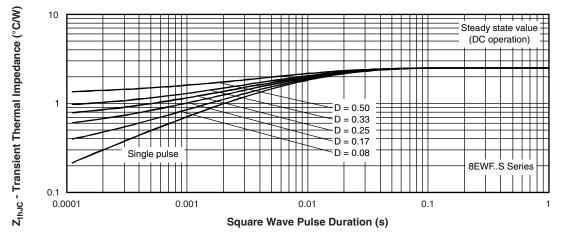
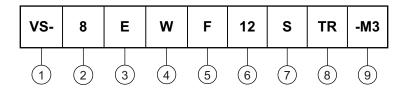


Fig. 14 - Thermal Impedance Z_{thJC} Characteristics

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ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (8 = 8 A)

3 - Circuit configuration:

E = single diode

4 - Package:

W = D-PAK

5 - Type of silicon:

F = fast soft recovery rectifier

6 - Voltage code x 100 = V_{RRM} ----

10 = 1000 V 12 = 1200 V

7 - S = surface mountable

- • TR = tape and reel

• TRR = tape and reel (right oriented)

• TRL = tape and reel (left oriented)

9 - Environmental digit:

-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-8EWF10S-M3	75	3000	Antistatic plastic tubes				
VS-8EWF10STR-M3	2000	2000	13" diameter reel				
VS-8EWF10STRL-M3	3000	3000	13" diameter reel				
VS-8EWF10STRR-M3	3000	3000	13" diameter reel				
VS-8EWF12S-M3	75	3000	Antistatic plastic tubes				
VS-8EWF12STR-M3	2000	2000	13" diameter reel				
VS-8EWF12STRL-M3	3000	3000	13" diameter reel				
VS-8EWF12STRR-M3	3000	3000	13" diameter reel				

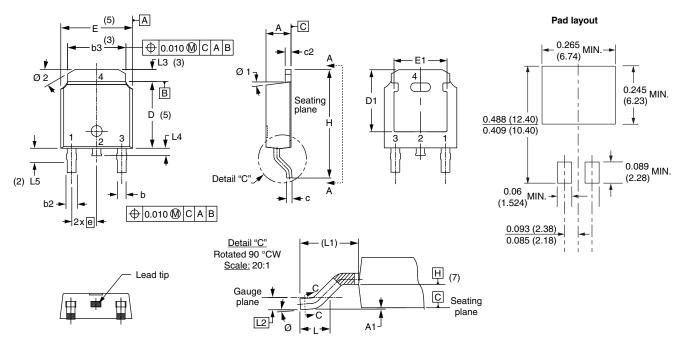
LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?95627</u>					
Part marking information	www.vishay.com/doc?95176				
Packaging information	www.vishay.com/doc?95033				
SPICE model	www.vishay.com/doc?97057				



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D-PAK (TO-252AA) "M"

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS INCHES		HES	NOTES	
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	2.18	2.39	0.086	0.094	
A1	-	0.13	-	0.005	
b	0.64	0.89	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	3
С	0.46	0.61	0.018	0.024	
c2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	5
D1	5.21	-	0.205	-	3
Е	6.35	6.73	0.250	0.265	5
E1	4.32	-	0.170	-	3

SYMBOL	MILLIMETERS		INCHES		NOTES
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
е	2.29	BSC	0.090	BSC	
Н	9.40	10.41	0.370	0.410	
L	1.40	1.78	0.055	0.070	
L1	2.74 BSC		0.108	REF.	
L2	0.51	BSC	0.020 BSC		
L3	0.89	1.27	0.035	0.050	3
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	2
Ø	0°	10°	0°	10°	
Ø1	0°	15°	0°	15°	
Ø2	25°	35°	25°	35°	

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Section C C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip
- (5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (6) Dimension b1 and c1 applied to base metal only
- (7) Datum A and B to be determined at datum plane H
- (8) Outline conforms to JEDEC® outline TO-252AA



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